No.	LD -19Z60A
DATE	DEC. 19. 2007

TECHNICAL

LITERATURE

FOR

TFT - LCD module

These parts have corresponded with the RoHS directive.

MODEL No. LQ084V3DG02

The technical literature is subject to change without notice.

So, please contact SHARP or its representative before designing your product based on this literature.

Engineering department Mobile LCD Division II MOBILE LIQUID CRYSTAL DISPLY GROUP SHARP CORPORATION

RECORDS OF REVISION

LQ084V3DG02

SPEC No.	DATE	REVISED		SUMMARY	NOTE
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LD-19Z60A	DEC.19.2007	_	_		1st Issue
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1 Applicable TFT-LCD module

This specification applies to the color TFT-LCD module, LQ084V3DG02.

2 Overview

This module is a color active matrix transmissive LCD module incorporating amorphous silicon TFT (Thin Film Transistor).

It is composed of a color TFT-LCD panel, driver ICs, control circuits and power supply circuitry and a backlight unit. Graphics and texts can be displayed on a 640 x RGB x 480 dots panel with 262,144 colors by feeding 18 bit data signal (6bit/each of R,G,B), 4(four) timing signals, +3.3V DC power supply for TFT-LCD and AC power supply for backlight.

(Note: Backlight-driving DC/DC converter and the wire harness are not built in this module.)

- Fine images with stripe aligned 307,200 pixels on 8.4 inch diagonal screen
- Adapting a wide viewing angle technology [best viewing angle: 6 o'clock direction]
- High contrast, thanks to active matrix drive system
- AG(Anti Glare) polarizing filter
- Light and slim compact module (2 o'clock direction is also available by the function to flip the screen horizontally or vertically)
- · Natural coloring reproducibility by employing normally-white-mode, which has good nature in coloring
- Image inversion both horizontally and vertically
- This module is adapted to RoHS compliance.

3 Mechanical Specifications

items	specifications	unit
Display size (Diagonal)	21.4 (8.4")	cm
Active display area	170.88 (H) x 128.16 (V)	mm
Pixel format	640(H) x RGB x 480(V)	dot
	(1 pixel=R+G+B dots)	_
Pixel pitch	0.267 (H) x 0.267(V)	mm
Pixel configuration	R,G,B vertical stripe	-
LCD mode	Normally white/Twisted Nematic	_
Dimension *	199.5 (W) x 149.5 (H) x T.B.D.(D)	mm
Mass	T.B.D.	g

^{*}Fig.1 shows dimensions of the module.

4 Input Signal Assignment

.1 TFT-LCD Panel driving section

CN1 Used connector: IMSA-9637S-33Y902 (IRISO ELECTRONICS CO.,LTD.)

Pin No.	Symbol	Function	Polarity
1	GND		
2	CK	Clock signal for sampling each datum	
3	Hsync	Horizontal Sync signal	Negative
4	Vsync	Vertical Sync signal	Negative
5	GND		
6	R0	RED Data signal (LSB)	
7	R1	RED Data signal	
8	R2	RED Data signal	
9	R3	RED Data signal	
10	R4	RED Data signal	
11	R5	RED Data signal (MSB)	
12	GND		
13	G0	GREEN data signal (LSB)	
14	G1	GREEN data signal	
15	G2	GREEN data signal	
16	G3	GREEN data signal	
17	G4	GREEN data signal	
18	G5	GREEN data signal (MSB)	
19	GND		
20	В0	BLUE data signal (LSB)	
21	B1	BLUE data signal	
22	В2	BLUE data signal	
23	В3	BLUE data signal	
24	B4	BLUE data signal	
25	B5	BLUE data signal (MSB)	
26	GND		
27	ENAB	Data Enable signal	[Note 4-1]
		(Control signal for image location in horizontal direction)	
28	Vcc	Power supply in	
29	Vcc	Power supply in	
30	R/L	Horizontal scanning direction control signal	[Note 4-2]
2 1	U/D	(Rightwards/Leftwards) Vertical scanning direction control signal	FNIoto 4 21
31	U/D	Vertical scanning direction control signal (Upwards/downwards)	[Note 4-2]
32	NC	(Opwarus/downwarus)	
33	GND		
33	GND		

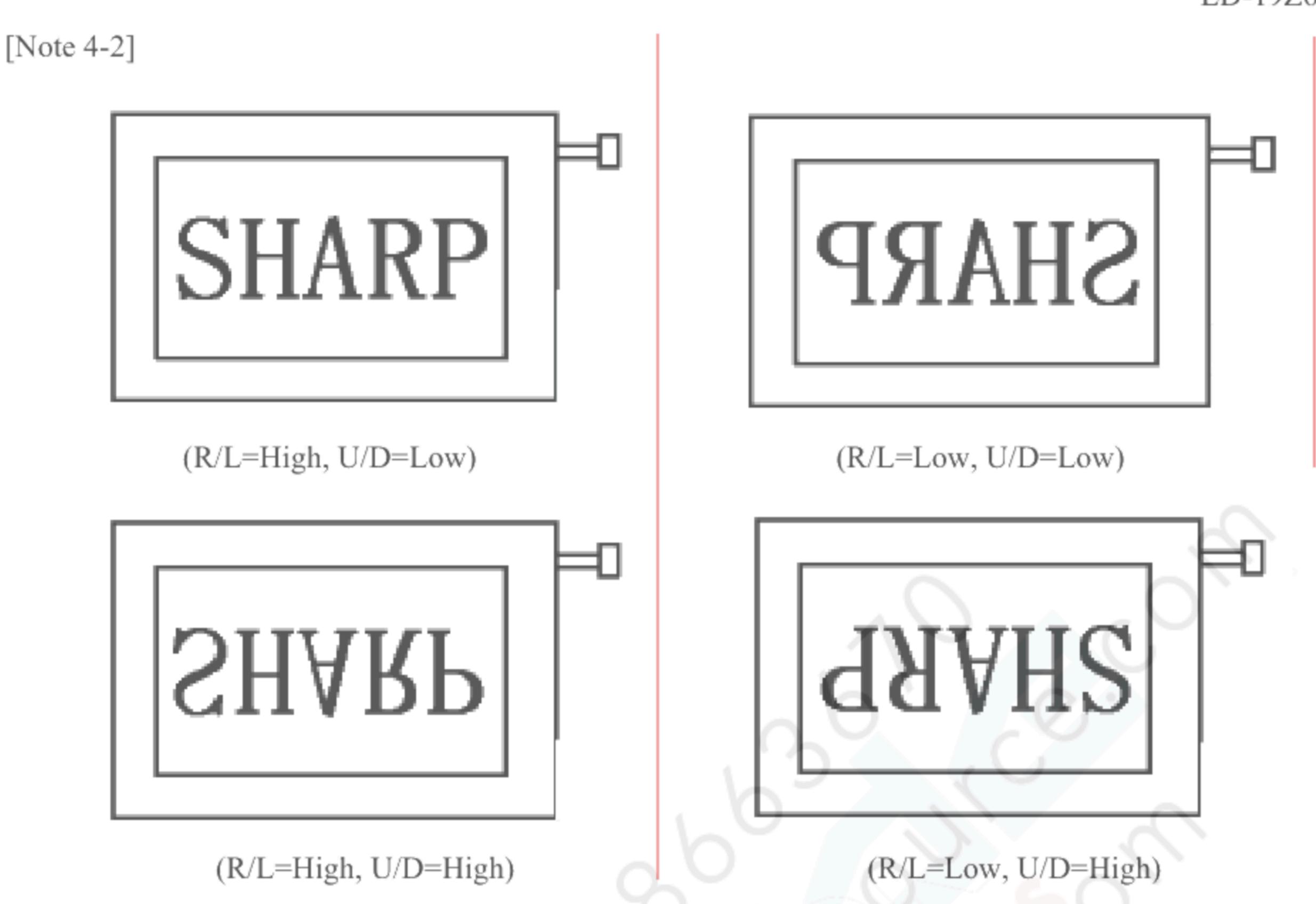
The front shield case and back shield case is internally grounded to GND of the module.

[Note 4-1]

The horizontal display location is designated and controlled by rising timing of ENAB signal.

However if ENAB signal is fixed to "Low", display location is designated by the default setting in the module.

(Don't use the module by fixing ENAB to "High")See: Chapter 7-2



4.2 Backlight section

Used connector: SM04B-SRSS-TB(LF)(SN) (JST)

CN2

Corresponding connector: SHR-04V-S-B (JST)

Pin no.	Symbol		Function
1	+ch2	Power supply for LED	(ch2 High voltage side)
2	+ch1	Power supply for LED	(ch1 High voltage side)
3	— ch1	Power supply for LED	(ch1 Low voltage side)
4	— ch2	Power supply for LED	(ch2 Low voltage side)

5 Absolute Maximum Ratings

Parameter	Symbol	Condition	Ratings	Unit	Remark
Input voltage	VI	Ta=25°C		V	[Note 5-1]
Supply voltage	Vcc	Ta=25°C	0 ~ +4.0	V	_
Storage temperature	Tstg	_	-30 ~ +80	°C	
Operating temperature (Panel surface)	Торр	_	-30 ~ +80	°C	[Note 5-2,3,4]

[Note 5-1] CK, R0 ~ R5, G0 ~ G5, B0 ~ B5, Hsync, Vsync, ENAB, R/L and U/D

[Note 5-2] Humidity: Less than 95%RH at Ta ≤ 40°C and

Maximum wet-bulb temperature must not exceed 39°C at Ta>40°C, with no condensation.

[Note 5-3] The operating temperature only guarantees operation of the circuit. For contrast, speed response, and other factors related to display quality, judgment is done using the ambient temperature $Ta = \pm 25$ °C.

[Note 5-4] This rating applies to all parts of the module and should not be exceeded.

6 Electrical characteristics

6.1 TFT-LCD Panel driving section

т.		25	00
1 a	_	20	

	w-*					
Parameter	Symbol	Min	Тур	Max	Unit	Remarks
Supply voltage	Vcc	+3.0	+3.3	+3.6	V	[Note6-1]
Current dissipation	Icc	-	200	360	mA	[Note6-2]Vcc=3.3V
Allowed input ripple voltage	V_{RF}	-	-	100	mV p-p	
Input voltage ("Low" state)	V_{IL}	-	-	0.8	V	[Note6-3]
Input voltage ("High" state)	V_{IH}	2.1	_	-	V	
	I.o.	10.0		100	^	V _I =0V
Input leakage current (low)	I _{OL1}	-10.0	-	10.0	μΑ	[Note6-4]
	I _{OL2}	-800			^	$V_I=0V$
		-800	_	_	μΑ	[Note6-5]
	I _{OL} 3	-10.0		10.0		$V_I=0V$
		-10.0	_	10.0	μΑ	[Note6-6]
	IOIII	-10.0	-	10.0	μΑ	V _I =Vcc
Input leakage current (High)	I _{OH1}					[Note6-4]
	I _{OH2}	-10.0	+	10.0	μΑ	V _I =Vcc
						[Note6-5]
	I _{OH3}	- 0		800	μΑ	V _I =Vcc
						[Note6-6]

[Note6-1] Vcc turn-on/off conditions

 $0 < t1 \le 15 ms$

 $0 < t2 \le 10 \text{ms}$

 $0 < t3 \le 100 ms$

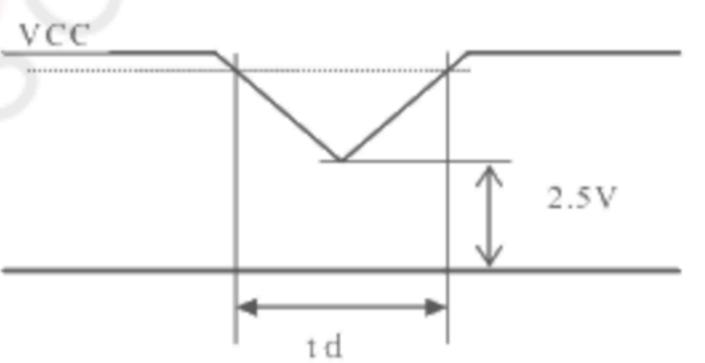
 $0 < t4 \le 1s$

t5 > 200ms

Vcc-dip conditions

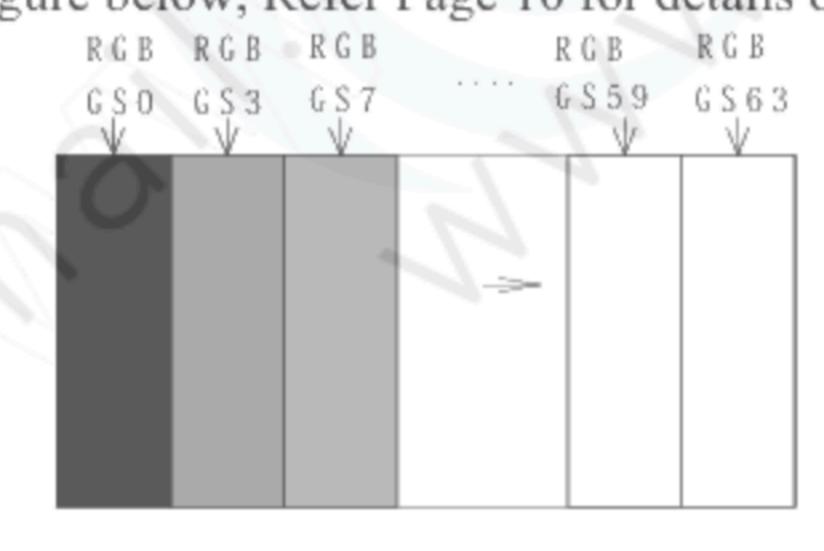
- 1) At $2.5V \le Vcc$ $td \le 10ms$
- At Vcc < 2.5V
 Vcc dip conditions should also follow the Vcc turn-on/off conditions

data 0.9VCC 0.9VCC 0.9VCC VCC data 14 to the second second



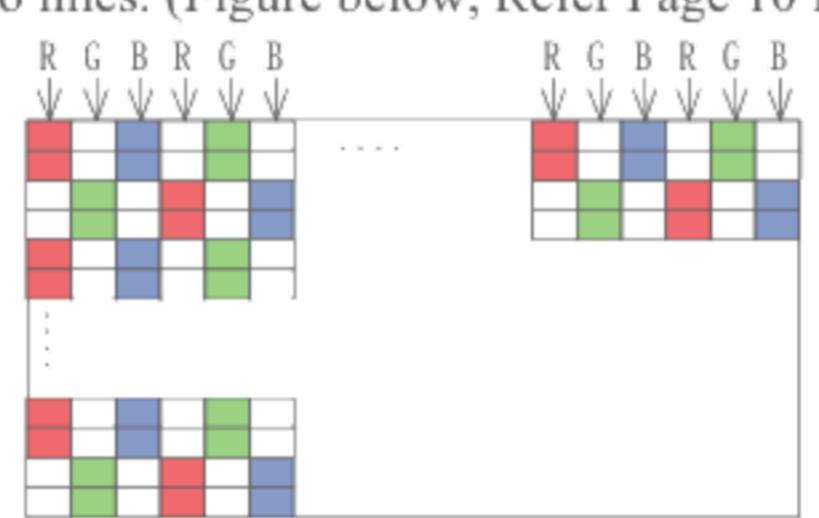
[Note6-2] Current dissipation (Typ.):

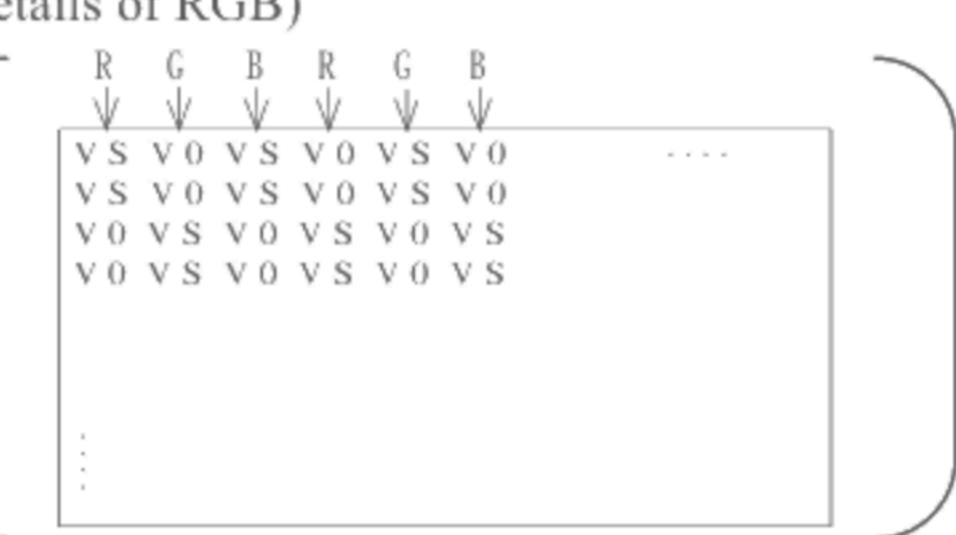
When Monochrome 16 level-gray-bar pattern is displayed (Figure below, Refer Page 10 for details of RGB)



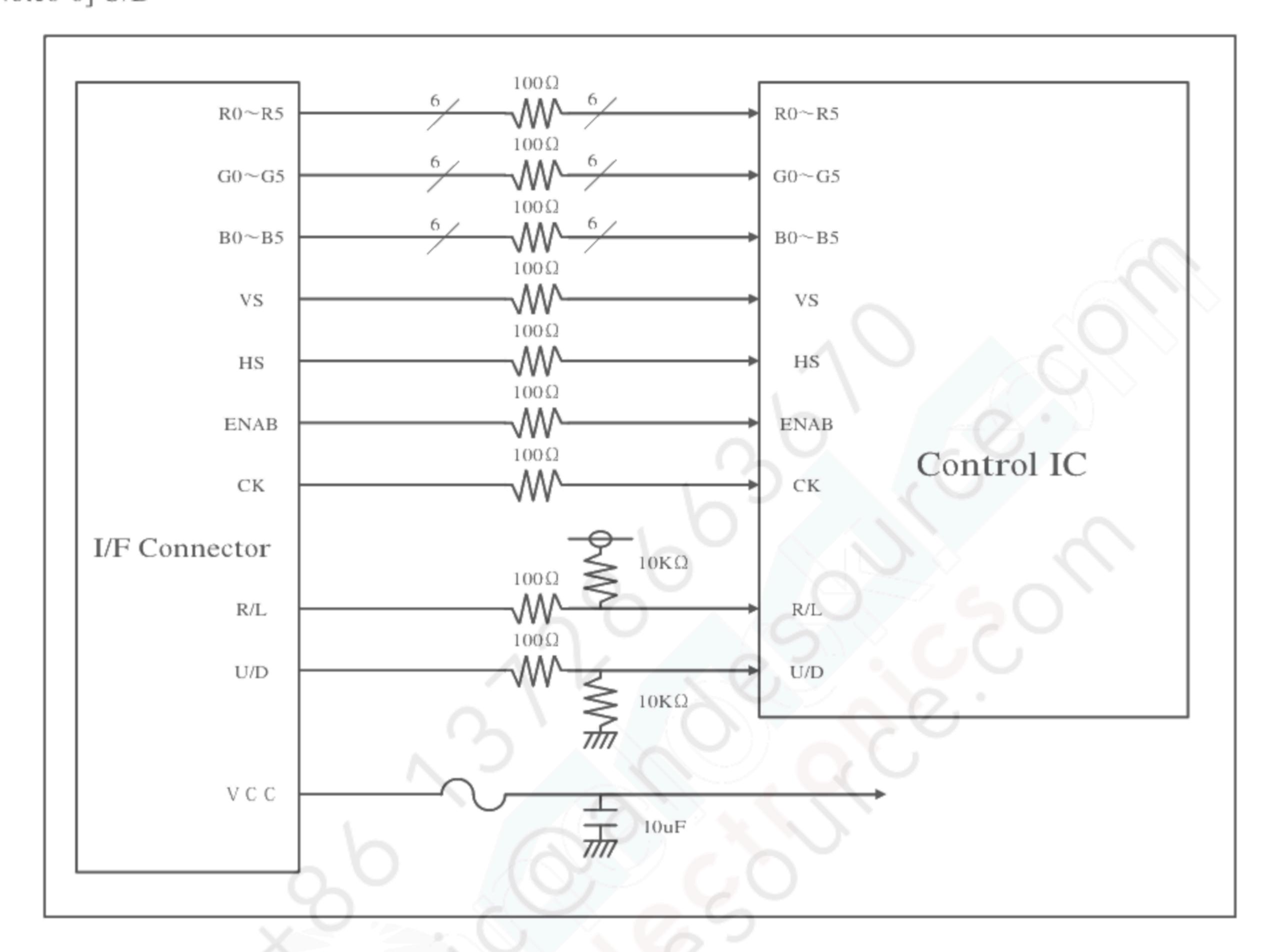
Current dissipation(Max):

When VS(V63) and V0 stripe pattern are displayed alternately at intervals of two lines. (Figure below, Refer Page 10 for details of RGB)





[Note6-3] CK, R0~R5, G0~G5, B0~B5, Hsync, Vsync, ENAB, R/L and U/D [Note6-4] CK, R0~R5, G0~G5, B0~B5, Hsync, Vsync, and ENAB [Note6-5] R/L [Note6-6] U/D



6.2 Backlight driving Section

The backlight system is an edge-lighting type with white-LED.

The characteristics of LED are shown in the following table.

(It is usually required to measure under the following condition.

condition: I_L =100mA/Constant current drive, Ta=25°C±2°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark
LED voltage	V_{L}	_	(21)	_	V	
LED current range	I_L	_	100	T.B.D.	mA	Value for one channel
Number of circuit channel		_	2	_		[Note 1]
Lamp power consumption	W_L	_	(4.2)	_	W	[Note 2]
Life time (LCD module)	L _L	_	(50,000) .	_	Hour	[Note 3]

[Note 1] The LED backlight is composed of 2 channels which 7 LED is connected in series.

[Note 2] Calculated value for reference ($I_L \times V_L \times 2$ channel)

[Note 3] ①Lighting condition:

- The state of the LCD module installation: Landscape position and standing position
- Atmosphere temperature: 25°C
- ·Lighting current: 100mA (Constant current drive/Continuous turning on)

2 Definition of Life time:

Brightness becomes 50% of the original value (under condition 1)

7 Timing Characteristics of Input Signals

Timing diagrams of input signal are shown in Fig.2.

7.1 Timing Characteristics

	Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
Clock	Frequency	1/Tc	G-ANN	25.18	28.33	MHz	
	"High" time	Tch	5		U -	ns	
Clock Data Hsync Horizont Phase diff Hsync ar	"Low" time	Tcl	10) -	ns	
Data	Setup time	Tds	5		-	ns	
	Hold time	Tdh	10	(O-	-	ns	
Hsync	Period	TH	30.00	31.78		μs	
			750	800	900	clock	
	Pulse width	ТНр	2	96	200	clock	
Vsync	Period	TV	515	525	560	line	
Vsync	Frequency	1/Tv	50	60	-	Hz	[Note7-1]
	Pulse width	TVp	1	-	34	line	
Horizont	tal display period	THd	640	640	640	clock	
	fference between nd clock	ТНс	10	-	Tc-10	ns	
	fference between nd Vsync	TVh	0	-	ТН-ТНр	clock	
Vertical	display period	TVs	34	34	34	line	

Note7-1) In case of lower frequency, the deterioration of display quality, flicker etc., may occur.

Please use this module in more than 50Hz.(1/Tv)

7.2 Display Position in horizontal direction

Display position in horizontal direction is designated by rising timing of ENAB signal.

Parameter		Symbol	MIN	TYP	MAX	Unit	Note
ENAB signal	Setup time	Tes	5	-	Tc -10	ns	
	Pulse width	Тер	2	640	TH-10	clock	
Phase difference	Phase difference between Hsync and		44	_	TH-664	clock	
ENA	AB signal						

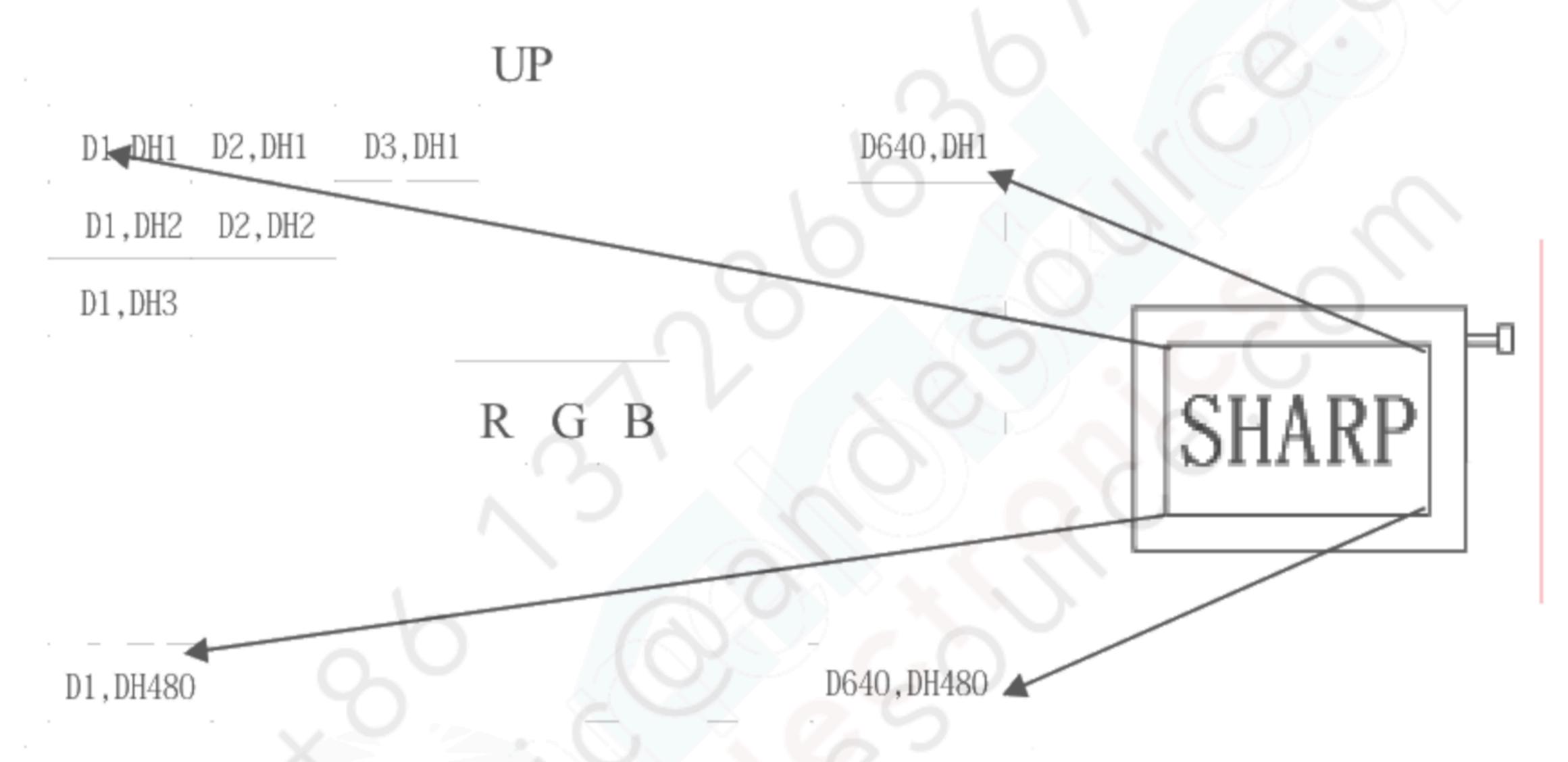
When ENAB is fixed to "Low", the horizontal display will starts from the clock C104 (clock) as shown in Fig.2. When the phase difference is not greater than 104 clock, hold ENAB terminal in "High" state for more than (104-THe), otherwise display will start from C104 (clock).

7.3 Display position in vertical direction

Display start position in vertical direction is fixed to the 34th line.

7.4 Input signal and display on the screen

Display position of input data



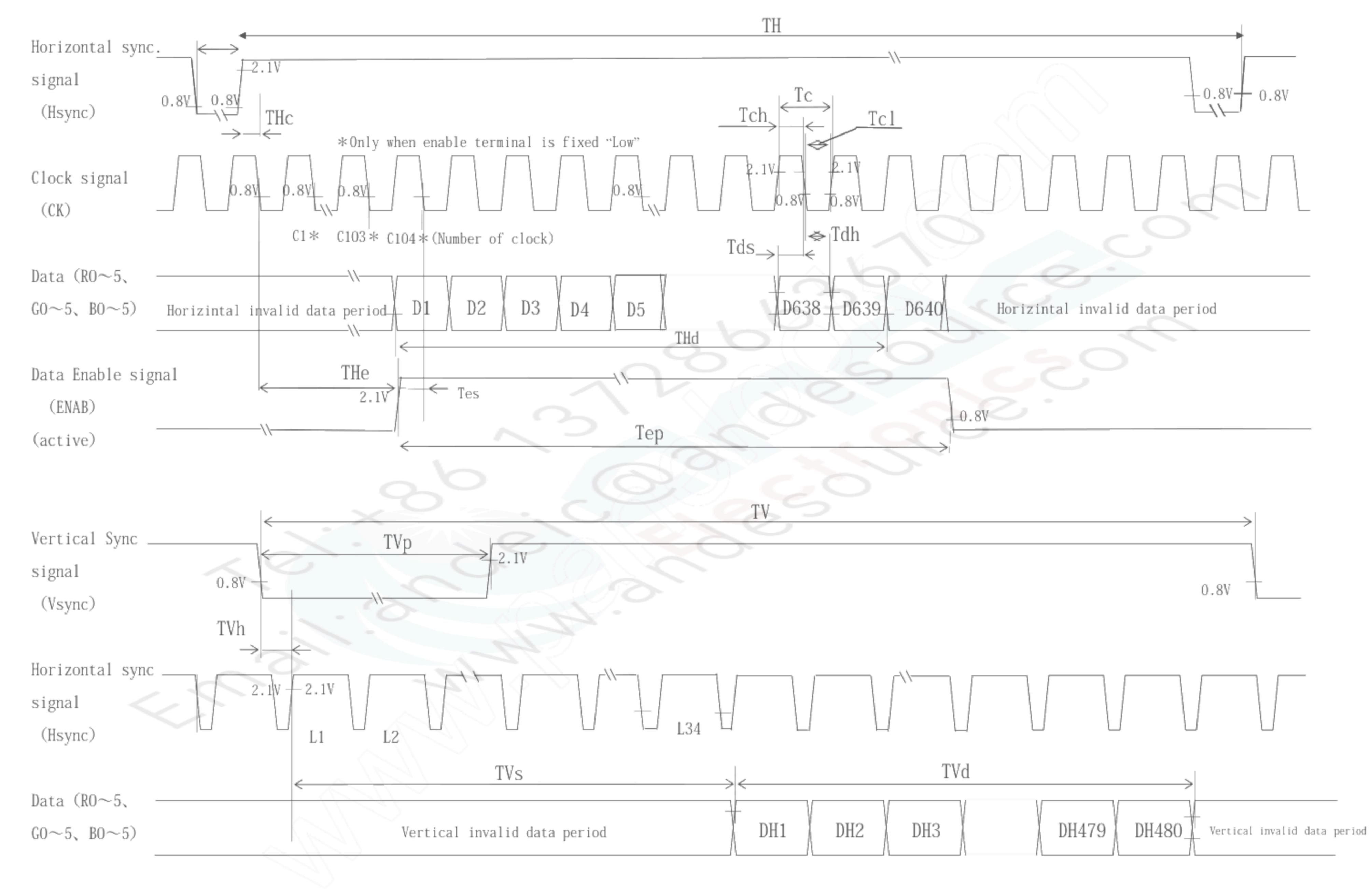


Fig 2. Input signal waveform

8 Input Signals, Basic Display Colors and Gray Scale of Each Color

-	8 Input Signals,	Dasic I	Basic Display Colors and Gray Scale of Each Color																	
	Colors &									Data	sign	al								
	Gray scale	Gray Scale	R0	R1	R2	R3	R4	R5	G0	G1	G2	G3	G4	G5	В0	В1	В2	В3	В4	В5
	Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	-	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
[Green	-	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Color	Cyan	-	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
CO	Red	-	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
asi	Magenta	-	1	1	1	1	1	1	0	0	0	0	0	0	1_/	1	1	\searrow 1	1	1
l ^m	Yellow	-	1	1	1	1	1	1	1	1	1	L	1	1	0	0	0	0	0	0
	White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ed	⇧	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
of R	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
<u>o</u>	⇧	\downarrow						5	\vee						→					
Sca	Û	\downarrow				<u> </u>							-							
ay (Brighter	GS61	1	0	1	1	1) 1	0	0	0	0	0	0	0	0	0	0	0	0
5	Û	GS62	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
Щ	Red	GS63	1	1	1	\1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
reen	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	⇧	GS1	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
) Jo	Darker	GS2	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
ale	⇧	\downarrow															1	/		
Sc	Û	V				\vee)-			\cup		ν <u> </u>								
ray	Brighter	GS61	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0
10	Û	GS62	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0
\sqcup	Green	GS63	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
le le	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
\mathbb{R}	1	GS1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
e of	Darker	GS2	0	0	0	0	0	0	0	0	0	0	()	0	0	1	0	0	0	0
Scal	Î	4			121	/= -				<u> </u>						1				
	1ì	- V	0		0	ν <u> </u>	-					ν <u> </u>								
Gray	Brighter	GS61	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1
	DI	GS62	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1 1
	Blue O: Low level voltage	GS63	.0	0	- 0	U	U	0	0	0	- 0	-0	0	0	1	1	1	1	1	1

^{0:} Low level voltage, 1: High level voltage

Each basic color can be displayed in 64 gray scales from 6 bit data signals. According to the combination of total 18 bit data signals, the 262,144-color display can be achieved on the screen.

9 Optical Specification

Ta=25°C, Vcc=+3.3V

Parameter		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Viewing angle	Horizontal	θ21, θ22	CR≥10	50	65	_	° (Deg.)	[Note9-1,4]
Range	Vertical	θ11		40	55	_	° (Deg.)	
		θ 12		45	60	-	° (Deg.)	
Contrast ratio		CR max	Best viewing	400	600	_	-	[Note9-2]
			angle					
Response time	Rise	Tr	$\theta = 0^{\circ}$	_	5	15	ms	[Note9-3]
	Fall	Td		_	21	40	ms	
Chromaticity of white		X		T.B.D.	(0.313)	T.B.D.		[Note9-4]
		у	IL=100mA	T.B.D.	(0.329)	T.B.D.		
Luminance		Y		(320)	(400)		cd/m ²	

The optical specifications are measured 30 minute after turning LED on and in a dark room or equivalent condition, according to the method shown in below. (Condition: $I_L = 100 \text{mA}$)

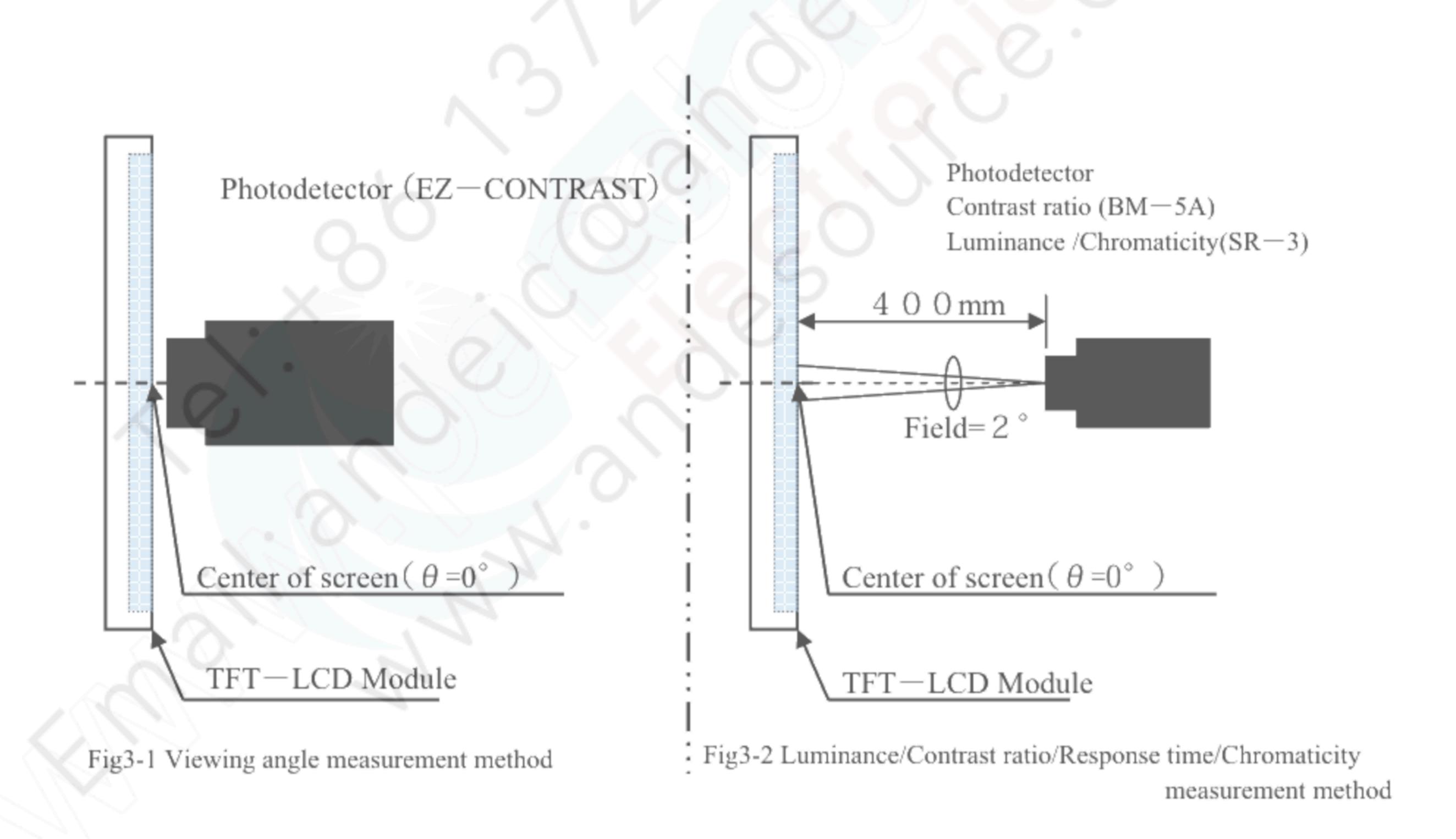
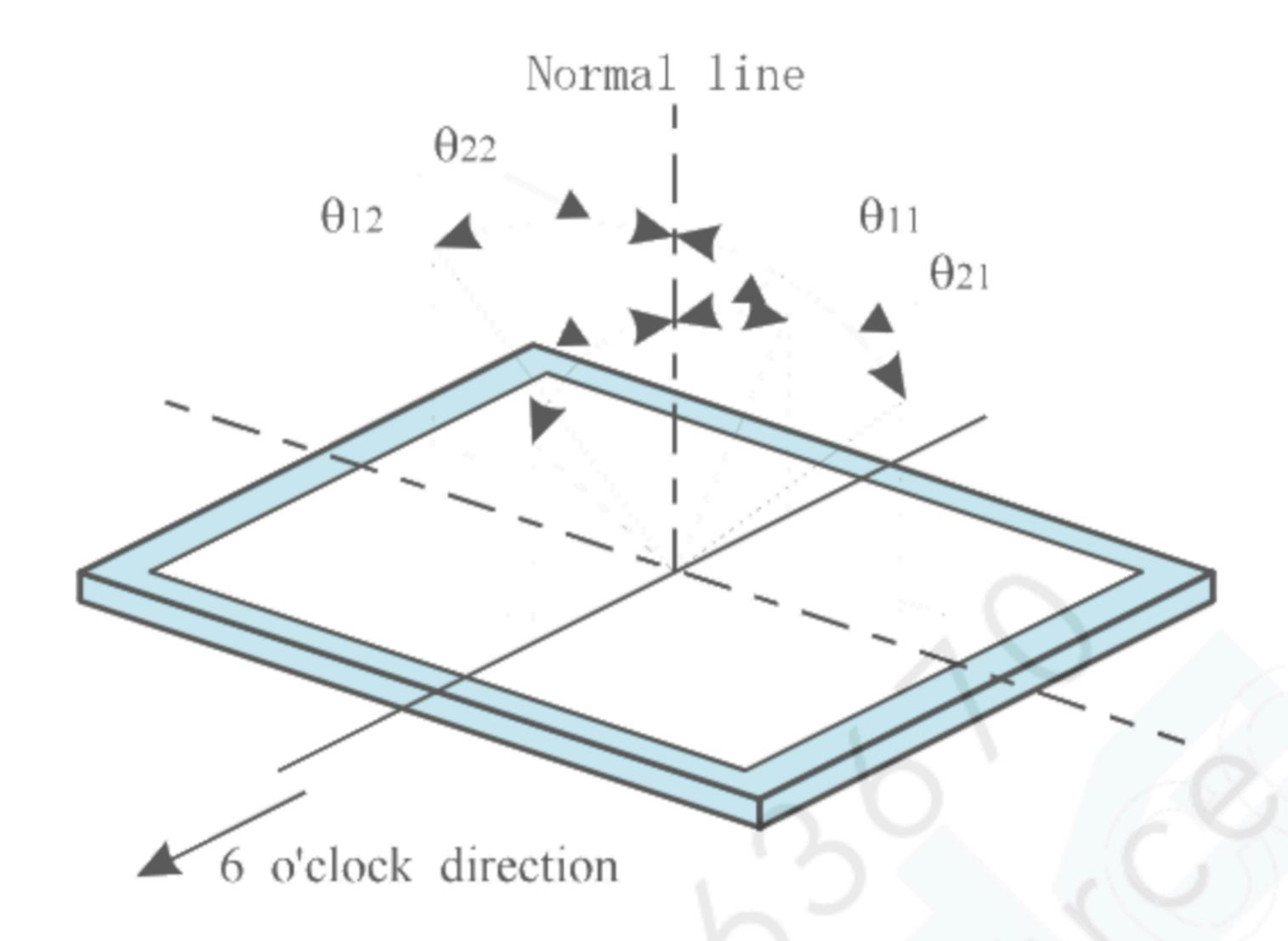


Fig3 Optical characteristics measurement method

[Note9-1] Definitions of viewing angle range:



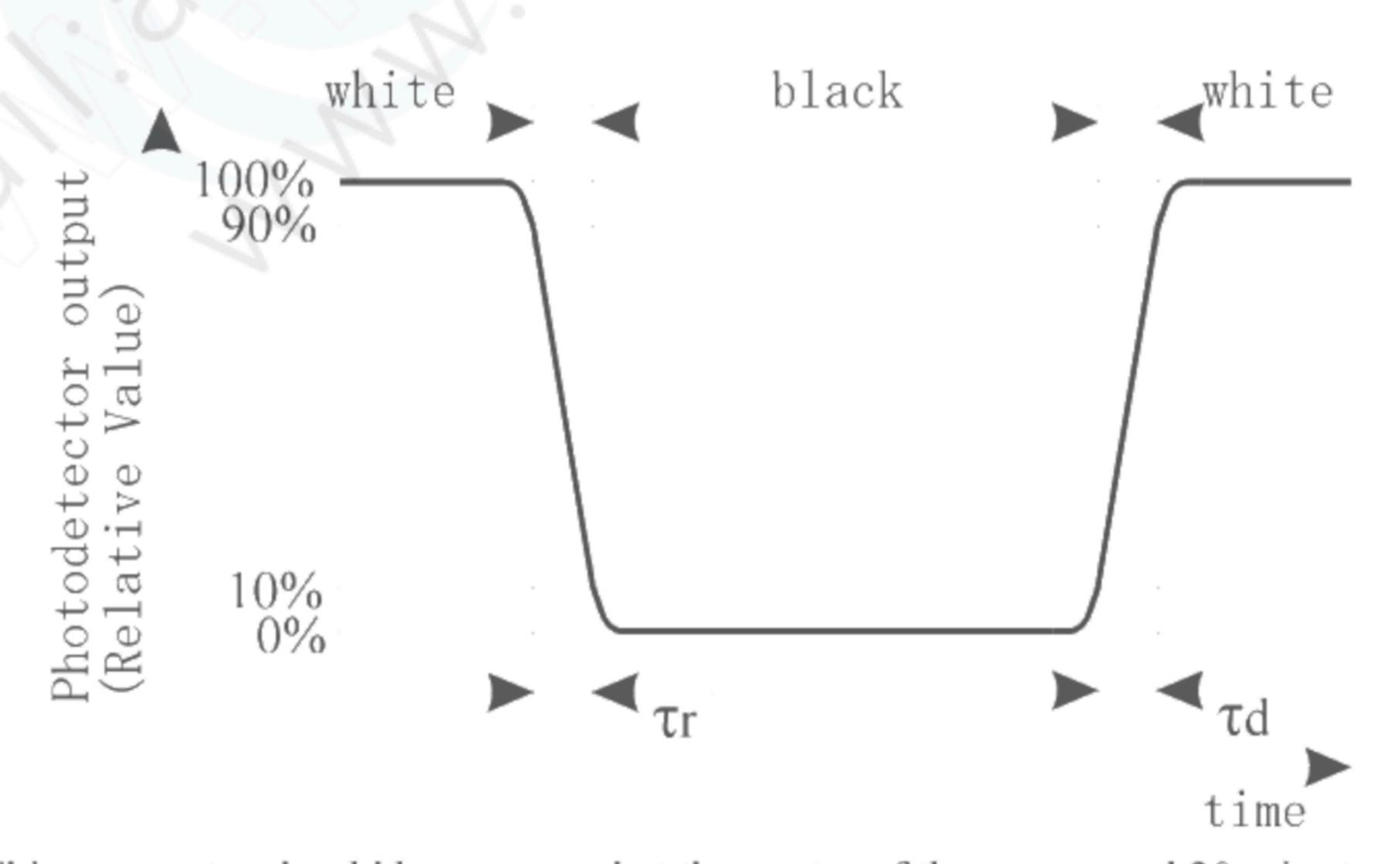
The best viewing angle of this module is slightly leaned to $\,6\,$ o'clock from normal line. In the field where $\,\theta_{\,12}\,$ exceeds this angle, gray-scale is reversed partially. The gray-scale in the field of 12 o'clock direction is brighter than that of $\,6\,$ o'clock direction and isn't reversed.

[Note9-2] Definition of contrast ratio:

The contrast ratio is defined as the following.

[Note9-3] Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal between "black" and "white" alternatively.



[Note9-4] This parameter should be measured at the center of the screen and 30 minutes after turn-on.

The characteristics are measured when the driver circuit is not powered.

10 Display Qualities

Please refer to the Outgoing Inspection Standard.

11 Handling Instruction

- 11.1 Assembling the module
 - Be sure to design the cabinet so that the module can be installed without any extra stress such as warp or twist.
 - 2) Please power off the module before you connect or disconnect input connector.
 - Make sure to connect module's metal shield case to GND of DCDC converter circuit.

If its connection is not made perfectly, some of the following problems may occur.

- a) Increase of noise caused by backlight
- b) Unstable output from DCDC converter circuit
- c) Possibly over-heat in some section

11.2 Instruction for assembling

- Since the front polarizer is easily damaged, pay attention to avoid rubbing with something hard or sharp.
- 2) How to eliminate dust on polarizer.
 - •Blow dust away by N₂ blower having measures of electrostatics
 - •Since the front polarizer is easily damaged, wiping dust off is not adequate.
 If the polarizer is soiled, it is suggested to peel dust off by using adhesive surface of adhesive tape.
- 3) When the metal section [shield case or shield back case] is soiled, wipe it off with dry and soft cloth. If not so easy, breathe upon it then wipe off. If the water droplet or fat is left for long term, it may cause stain or tarnish, it should be wipe off immediately.
- 4) Since TFT-LCD panel is made of glass substrate, dropping the panel or banging it against hard objects may cause cracking or fragmentation.
- Since CMOS LSIs are incorporated in this module, please pay special care to electrostatic while handling it, and earth human body.

11.3 Caution in product design

- 1)The notes and cautions below should be followed when product is designed with this module.
- 2) The module should be protected with cover to prevent salt content and/or water droplet. Take enough shielding countermeasure not to interfere to peripheral electronic device.
- 3) If a minute particle enters in the module and adheres to an optical material, it may cause display
 - non-uniformity issue, etc. Therefore, fine-pitch filters have to be installed to cooling and inhalation hole if you intend to install a fan.
 - 4) The LED used for this product is very sensitive to the temperature. Luminance decreases rapidlywhen it is used for a long time under the environment of the high temperature. Please consult our company when it is used under the environment like the above mentioned.

11.4 Others

The LCD has the nature that its performance is degradation by ultra-violet light. Don't leave the LCD module in direct sunlight or strong ultra violet ray.

If stored at the temperatures lower than the rated storage temperature, the LC may freeze and it may cause LCD panel damage. If storage temperature exceeds the specified rating, the molecular orientation of the LC may change to that of a liquid, and they may not revert to their original state. Store the module in normal room temperature.

The liquid crystal may leak out when the LCD is broken. If the liquid crystal drip into the eyes or mouth washes it out immediately.

The caution to other ordinal electronic component should be followed also.

Avoid the LCD to use and leave in the atmosphere with condensation and/or the high concentration of corrosive gases described below; Sulfurous gasses (ex; SO2(sulfur dioxide), CS2(carbon disulfide), H2S(hydrogen sulfide)), Cl2(chlorine), HCl(hydrogen chloride), NH3(ammonia) and so on.

12 Packing Form

- 12.1 Fig.4 shows packaging form.
- 12.2 Carton stock conditions
- a) Maximum number of Carton being stuck: 6)
- b) Maximum number of product contained: (0 Unit)
- c) Carton size: 408mm (W) x 203mm (H) x 244mm (D))
- d) Total mass (for 10Unit): Approximately 6kg
- e) Carton stock environment:

1) Temperature: 0 ~ 40°C 2) Humidity: Up to 60%RH

3) Ambiance: No gases bite into electronic components and wiring materials

4) Period: Approximately 3month

5) Unpacking: To prevent LCD module from damaging by ESD,

unpack the module with effective measure after controlling

humidity 50%RH or more.

13 Marking of product name

T.B.I).		

14 Miscellaneous

- a) Variable resister has been set optimally before shipment, so do not change any adjusted value. If adjusted value is changed, the specification may be not satisfied.
- b) Don't disassemble this module, it may cause malfunction.
- c) Image retention may occur when the fixed image is display for long time.
- d) Liquid crystal panel drive input FFC/FPC specification
 - The following FFC/FPC is recommended for input connector.
 [IMSA-9637S-33Y902 (IRISO Electronics co.,ltd.), 33pin 0.5mm pitch)]
 - The terminal of FFC/FPC of input connector recommend to be gold or gold plated.
 Because point of contact of the connection is gold plated.
- e) When any question or issue occurs, it shall be solved by mutual discussion.

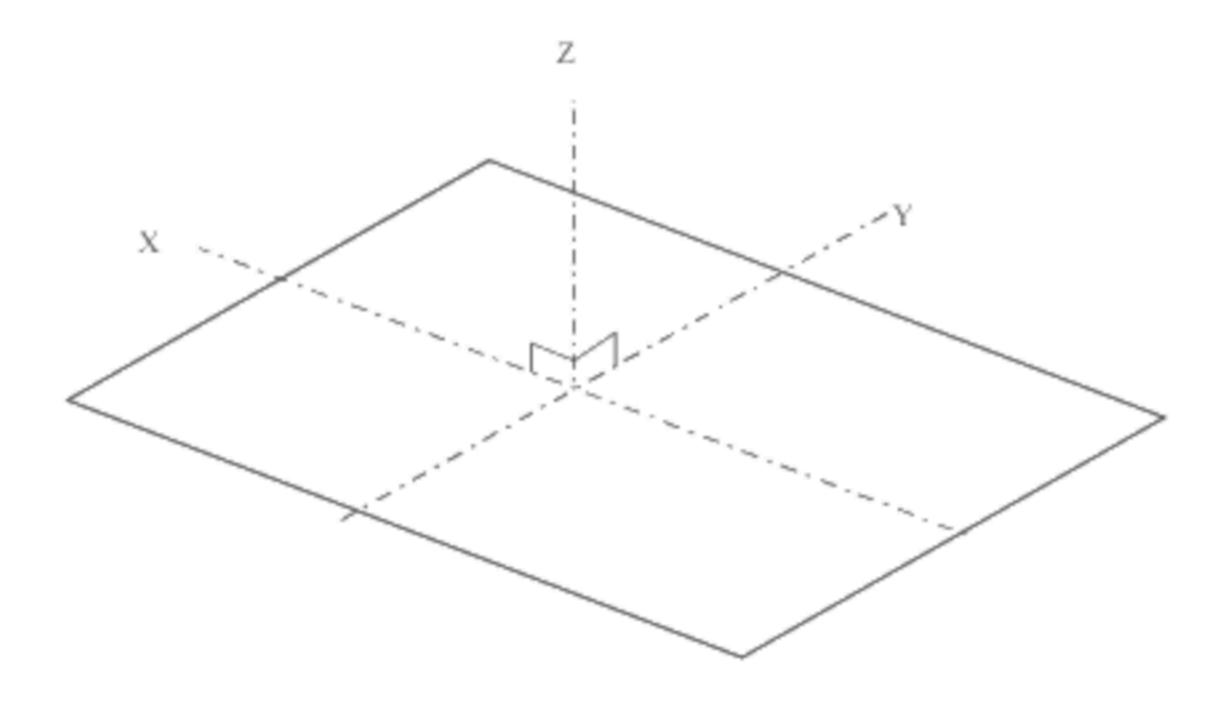
15 Reliability Test Items

No.	Test parameter	Conditions
1	High temperature storage test	Leaves the module at Ta=80°C for 240h
2	Low temperature storage test	Leaves the module at Ta=-30°C for 240h
3	High temperature	Operates the module at Ta=40°C;90~95%RH for 240h
	& high humidity operation test	(No condensation)
4	High temperature operation test	Operates the module with +80°C at panel surface for 240h
5	Low temperature operation test	Operates the module at Ta=-30°C for 240h
6	Strength against ESD	$\pm 200 V$ 200pF [0 Ω] one time for each terminal
7	Shock test	Max. acceleration: 686m/s ² (70G) Pulse width: 6ms, half sine wave
	(non- operating)	Direction: $\pm X, \pm Y, \pm Z$ once for each direction.
8	Vibration test	Frequency: 10~57Hz/Vibration width (one side):0.15mm
	(non- operating)	: 58~500Hz/ acceleration:19.6m/s ² Sweep time : 11 minutes
		Test period: 3 hours (1 hour for each direction of X,Y,Z)
9	Thermal shock test	-30°C[0.5h] ~ +80°C[0.5h] /50 cycle

[Result Evaluation Criteria]

Under the display quality test conditions with normal operation state, these shall be no change which may affect practical display function.

[Note] The directions of X, Y, Z are defined as below:



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